CRMLTU2312C

N-Channel 20V, 16mΩ Typ. Power MOSFET

Description

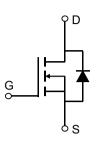
Features

• 20V, 6.5A

$$R_{DS(ON)}$$
 Typ = 16m Ω @ V_{GS} = 4.5V

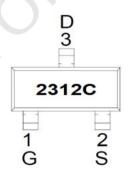
$$R_{DS(ON)}$$
 Typ = 20m Ω @ V_{GS} = 2.5 V

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free





D



Marking and Pin Assignment

Application

- Load Switch
- PWM Application
- Power Management

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLTU2312C	2312C	SOT-23	TAPING	13"	3000	120000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		20	V
V_{GS}	Gate-to-Source Voltage		±12	V
	Continuous Drain Current	T _A = 25°C	6.5	Α
l _D	Continuous Diam Current	T _A = 100°C	3.9	Α
I _{DM}	Pulsed Drain Current (1)		26	Α
P_{D}	Power Dissipation	T _A = 25°C	1.25	W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient ⁽²⁾)	100	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Char	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4	0.7	1	V
В	Chatia Dania Conner ON Desister (3)	$V_{GS} = 4.5V, I_D = 2A$	-	16	21	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 2.5V, I_D = 1.5A$	-	20	26	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance			594	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 10V,$ f = 1MHz	X-\	77	-	pF
C_{rss}	Reverse Transfer Capacitance	. 1191112		67	-	pF
Q_g	Total Gate Charge		U -	7.5	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 10V, I_{D} = 3A$	-	1.3	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 10 V, I _D - 0A	-	2	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.r ()	-	4.2	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 4.5V, V_{DD} = 10V$	-	13	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 3A$, $R_{GEN} = 3\Omega$	-	18	-	ns
t _f	Turn-Off Fall Time	>		5.8		ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	6.5	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	26	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V$, $I_S = 2A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 24 di/dt - 4004/us	-	5.8	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 3A$, di/dt = 100A/us	-	1.7	_	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

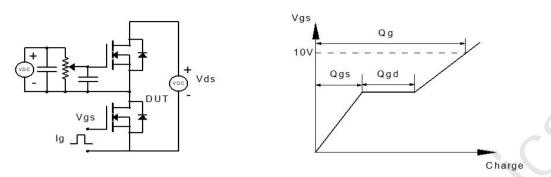


Figure 1: Gate Charge Test Circuit & Waveform

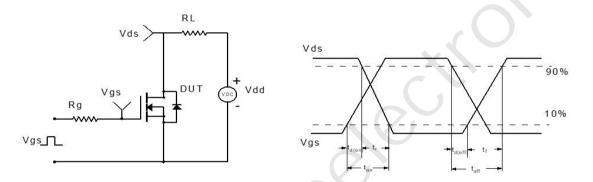


Figure 2: Resistive Switching Test Circuit & Waveform

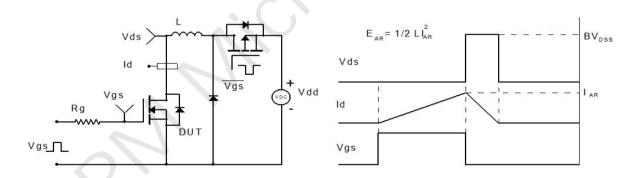


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

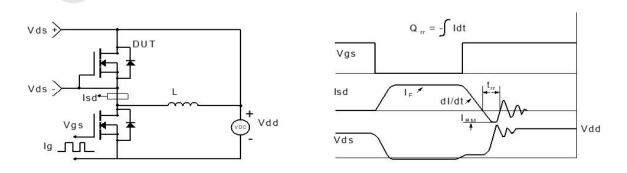
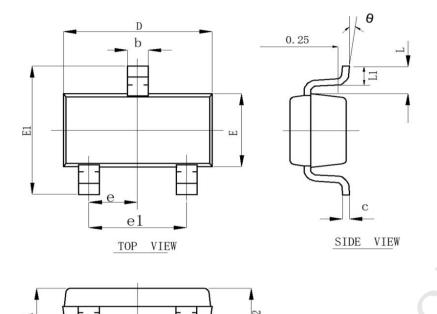


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(SOT-23)



SIDE VIEW

SYMBOL	MIN	MAX	
A	0.900	1. 150	
A1	0.000	0. 100	
A2	0.900	1.050	
b	0. 300	0. 500	
С	0.080	0. 150	
D	2. 800	3, 000	
Е	1. 200	1.400	
E1	2. 250	2.550	
L	0. 550 REF.		
θ	0°	8°	
L1	0. 300	0. 500	
е	0. 950 TYP.		
P1	1, 800	2.000	

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Contact information

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